

RoHS Compliant

CFast 2.0

SH250-CFast 2.0 Product Specifications



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Version 1.5



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Specifications Overview:

- **Compliance with SATA Revision 3.2**
 - SATA 6 Gb/s interface
 - ATA-compatible command set
 - Backward compatible with SATA 1.5/3 Gb/s
- **Capacity**
 - 10, 20, 40, 80, 160 GB
- **Performance¹**
 - Burst read/write: 600 MB/sec
 - Sequential read: Up to 560 MB/sec
 - Sequential write: Up to 510 MB/sec
 - Random read (4K): Up to 60,000 IOPS
 - Random write (4K): Up to 70,000 IOPS
- **Flash Management**
 - Low-Density Parity-Check (LDPC) Code
 - Global Wear Leveling
 - Flash bad-block management
 - Flash Translation Layer: Page Mapping
 - DataDefender™
 - S.M.A.R.T.
 - Device Sleep
 - ATA Secure Erase
 - TRIM
 - SMART Read Refresh™
 - SLC-liteX (P/E cycle: 100K)
- **NAND Flash Type: 3D TLC (BiCS3)**
- **MTBF: >3,000,000 hours**
- **Endurance (in drive writes per day: DWPD)**
 - 10 GB: 35.87 DWPD
 - 20 GB: 40.3 DWPD
 - 40 GB: 37.96 DWPD
 - 80 GB: 36.53 DWPD
 - 160 GB: 29.37 DWPD
- **Temperature Range**
 - Operating:
 - Standard: 0°C to 70°C
 - Wide: -40°C to 85°C
 - Storage: -55°C to 100°C
- **Power Consumption¹**
 - Supply voltage: 3.3V
 - Active mode: 420 mA
 - Idle mode: 75 mA
- **Form Factor**
 - CFast
 - Dimensions: 42.80 x 36.45 x 3.60, unit: mm
 - Net Weight: 9.33g ± 5%
- **Connector Type**
 - 7 + 17 pin female connector
- **Security**
 - AES 256-bit hardware encryption
- **Reliability**
 - Thermal Sensor
 - End-to-End Data Protection
- **Write Protect Switch (optional)**
- **RoHS Compliant**

Note:

1. Varies from capacities. The values for performances and power consumptions presented are typical and may vary depending on flash configurations or platform settings. The term idle refers to the standby state of the device.

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1. General Description

Apacer SH250-CFast 2.0 is the latest enhancement of conventional CFast form factor that delivers various technological advantages. It utilizes 3D NAND for higher capacity up to 160GB and provides more power efficiency than 2D NAND. This new flash memory card comes with SATA 6 Gb/s interface for higher performance and consists of SATA-based 7-pin signal segment and 17-pin for power and control purposes. Designed without DRAM on the internal controlling unit, SH250-CFast ensures data integrity by preventing data loss during a sudden power outage.

For data efficiency, SH250-CFast 2.0 delivers data transfer rates up to 560MB/s in sequential access and 70,000 IOPS in 4KB random access. In addition, Apacer CFast cards come with S.M.A.R.T. for lifetime monitoring. With Apacer’s SLC-liteX technology, SH250-CFast 2.0 performs with higher number of P/E cycles up to 100,000 times. Moreover, SH250-CFast 2.0 guarantees reliability of applications in harsh environments by implementing intelligent Flash Management algorithms and LDPC (Low Density Parity Check) ECC engine to extend SSD endurance and increase data reliability.

In terms of security, Advanced Encryption Standard (AES) ensures data security and provides users with a peace of mind. Furthermore, with End-to-End Data Protection, data integrity can be assured at multiple points in the path to enable reliable delivery of data transfers.

2. Functional Block

Apacer SH250-CFast 2.0 includes a single-chip controller and flash media. The controller integrates the flash management unit to support multi-channel, multi-bank flash arrays. Figure 2-1 shows the functional block diagram.

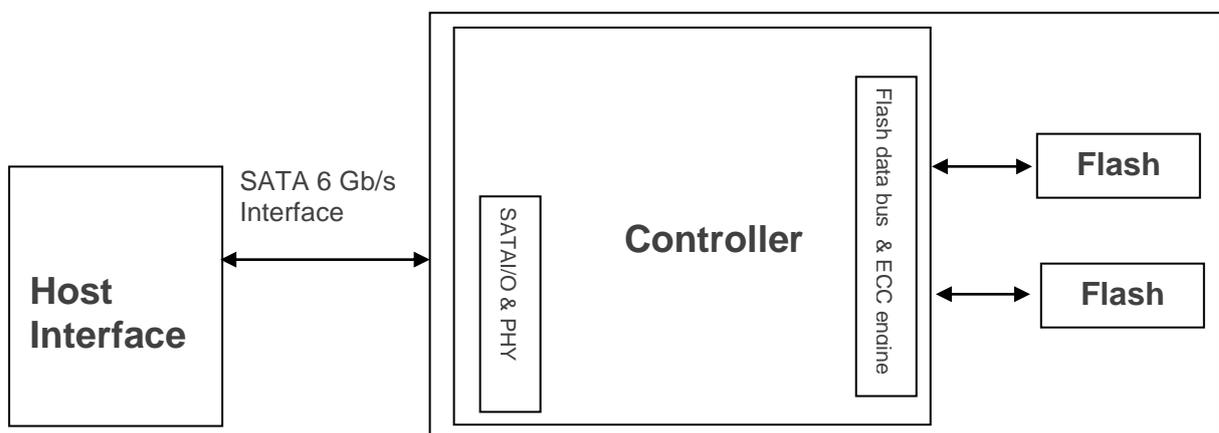


Figure 2-1 Functional Block Diagram

3. Pin Assignments

Table 3-1 describes SH250-CFast 2.0 signal segment, and Table 3-2, its power segment.

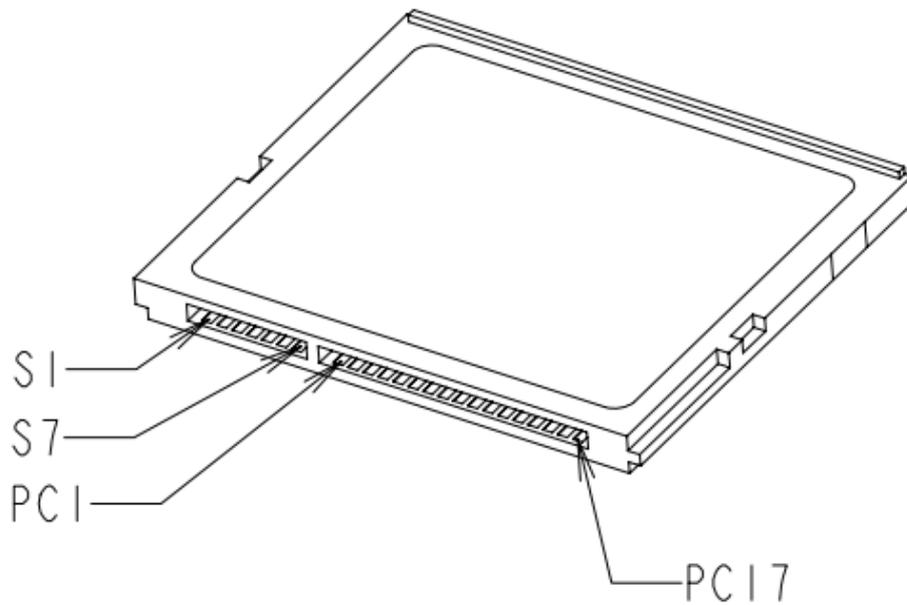


Figure 3-1 Pin Assignment

Table 3-1 Signal Segment

| Pin | Definition | Description |
|-----|------------|---------------------------------|
| S1 | GND | Ground |
| S2 | A+ | SATA Differential Signal Pair A |
| S3 | A- | |
| S4 | GND | Ground |
| S5 | B- | SATA Differential Signal Pair B |
| S6 | B+ | |
| S7 | GND | Ground |

Table 3-2 Power Segment

| Pin | Definition | Type | Description |
|------|-------------------------|-------------------|--------------------------------------|
| PC1 | CDI | Input | Card Detect In |
| PC2 | PGND | Device GND | Device GND |
| PC3 | DEVSLP ¹ | DEVSLP card input | DEVSLP enable |
| PC4 | No connect ² | Not available | Reserved |
| PC5 | No connect ² | Not available | Reserved |
| PC6 | No connect ² | Not available | Reserved |
| PC7 | PGND | Device GND | Device GND |
| PC8 | LED1 | LED Output | Power indicator |
| PC9 | LED2 | LED Output | Access indicator |
| PC10 | No connect ² | Not available | Reserved |
| PC11 | No connect ² | Not available | Reserved |
| PC12 | IFDet | GND | Card output, connect to PGND on card |
| PC13 | PWR | 3.3V | Device power (3.3V) |
| PC14 | PWR | 3.3V | Device power (3.3V) |
| PC15 | PGND | Device GND | Device GND |
| PC16 | PGND | Device GND | Device GND |
| PC17 | CDO | Output | Card Detect Out |

Notes:

1. Optional
2. Reserved by Apacer, please do not connect to a host.

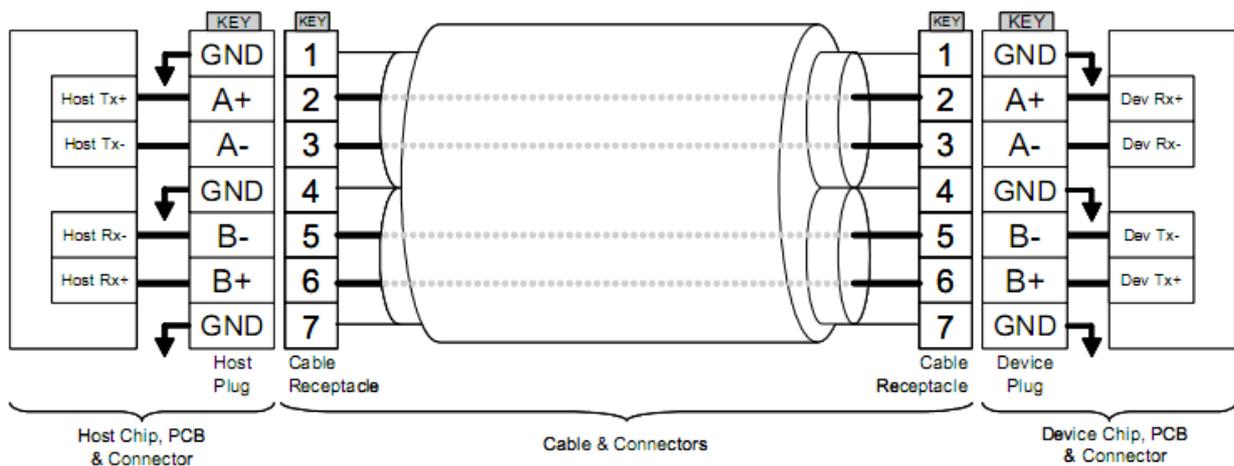


Figure 3-2 SATA Cable / Connector Connection Diagram

The connector on the left represents the Host with TX/RX differential pairs connected to a cable while the connector on the right shows the Device with TX/RX differential pairs also connected to the cable. Notice also the ground path connecting the shielding of the cable to the Cable Receptacle.

4. Product Specifications

4.1 Capacity

Capacity specifications of the SH250-CFast 2.0 are available as shown in Table 4-1. It lists the specific capacity and the default numbers of heads, sectors and cylinders for each product line.

Table 4-1 Capacity Specifications

| Capacity | Total bytes | Cylinders | Heads | Sectors | Total LBA |
|----------|-----------------|-----------|-------|---------|-------------|
| 10 GB | 10,012,778,496 | 16,383 | 16 | 63 | 19,556,208 |
| 20 GB | 20,014,718,976 | 16,383 | 16 | 63 | 39,091,248 |
| 40 GB | 40,018,599,936 | 16,383 | 16 | 63 | 78,161,328 |
| 80 GB | 80,026,361,856 | 16,383 | 16 | 63 | 156,301,488 |
| 160 GB | 160,041,885,696 | 16,383 | 16 | 63 | 312,581,808 |

Notes:

- Display of total bytes varies from operating systems.
- 1 GB = 1,000,000,000 bytes; 1 sector = 512 bytes.
- LBA count addressed in the table above indicates total user storage capacity and will remain the same throughout the lifespan of the device. However, the total usable capacity of the SSD is most likely to be less than the total physical capacity because a small portion of the capacity is reserved for device maintenance usages.

4.2 Performance

Performance of SH250-CFast 2.0 product family is available as shown in Table 4-2.

Table 4-2 Performance Specifications

| Performance | Capacity | 10 GB | 20 GB | 40 GB | 80 GB | 160 GB |
|--------------------------------|-------------------------------|--------|--------|--------|--------|--------|
| | Sequential Read (MB/s) | | 210 | 430 | 560 | 560 |
| Sequential Write (MB/s) | | 120 | 260 | 480 | 500 | 510 |
| Random Read IOPS (4K) | | 9,800 | 14,000 | 33,000 | 57,000 | 60,000 |
| Random Write IOPS (4K) | | 31,000 | 58,000 | 70,000 | 70,000 | 70,000 |

Notes:

- Results may differ from various flash configurations or host system setting.
- Sequential read/write is based on CrystalDiskMark 5.2.1 with file size 1,000MB.
- Random read/write is measured using IOMeter with Queue Depth 32.

4.3 Environmental Specifications

Environmental specifications of SH250-CFast 2.0 are shown in Table 4-3.

Table 4-3 Environmental Specifications

| Item | Specifications |
|-------------------------|--|
| Operating temp. | 0°C to 70°C (Standard); -40°C to 85°C (Wide) |
| Non-operating temp. | -55°C to 100°C |
| Operating vibration | 7.69 GRMS, 20~2000 Hz/random (compliant with MIL-STD-810G) |
| Non-operating vibration | 4.02 GRMS, 15~2000 Hz/random (compliant with MIL-STD-810G) |
| Operating shock | 50G, 11ms |
| Non-operating shock | 1500G, 0.5ms (compliant with MIL-STD-883K) |

Note: This Environmental Specification table indicates the conditions for testing the device. Real world usages may affect the results.

4.4 Mean Time Between Failures (MTBF)

Mean Time Between Failures (MTBF) is predicted based on reliability data for the individual components in SH250-CFast 2.0. Serving as statistical reference, the prediction result for SH250-CFast is more than 3,000,000 hours.

Note: The MTBF is predicated and calculated based on “Telcordia Technologies Special Report, SR-332, Issue 3” method.

4.5 Certification and Compliance

SH250-CFast 2.0 complies with the following standards:

- CE
- FCC
- RoHS
- MIL-STD-810G

4.6 Endurance

The endurance of a storage device is predicted by Drive Writes Per Day based on several factors related to usage, such as the amount of data written into the drive, block management conditions, and daily workload for the drive. Thus, key factors, such as Write Amplifications and the number of P/E cycles, can influence the lifespan of the drive.

Table 4-4 Endurance Specifications

| Capacity | Drive Writes Per Day |
|----------|----------------------|
| 10 GB | 35.87 |
| 20 GB | 40.3 |
| 40 GB | 37.96 |
| 80 GB | 36.53 |
| 160 GB | 29.37 |

Notes:

- This estimation complies with JEDEC JESD-219, enterprise endurance workload of random data with payload size distribution.
- Flash vendor guaranteed 3D SLC-liteX P/E cycle: 100K
- WAF may vary from capacity, flash configurations and writing behavior on each platform.
- 1 Terabyte = 1,024GB
- DWPD (Drive Writes Per Day) is calculated based on the number of times that user overwrites the entire capacity of an SSD per day of its lifetime during the warranty period. (3D SLC-liteX warranty: 5 years)

5. Flash Management

5.1 Error Correction/Detection

SH250-CFast implements a hardware ECC scheme, based on the Low Density Parity Check (LDPC). LDPC is a class of linear block error correcting code which has apparent coding gain over BCH code because LDPC code includes both hard decoding and soft decoding algorithms. With the error rate decreasing, LDPC can extend SSD endurance and increase data reliability while reading raw data inside a flash chip.

5.2 Bad Block Management

Current production technology is unable to guarantee total reliability of NAND flash memory array. When a flash memory device leaves factory, it comes with a minimal number of initial bad blocks during production or out-of-factory as there is no currently known technology that produce flash chips free of bad blocks. In addition, bad blocks may develop during program/erase cycles. Since bad blocks are inevitable, the solution is to keep them in control. Apacer flash devices are programmed with ECC, page mapping technique and S.M.A.R.T to reduce invalidity or error. Once bad blocks are detected, data in those blocks will be transferred to free blocks and error will be corrected by designated algorithms.

5.3 Global Wear Leveling

Flash memory devices differ from Hard Disk Drives (HDDs) in terms of how blocks are utilized. For HDDs, when a change is made to stored data, like erase or update, the controller mechanism on HDDs will perform overwrites on blocks. Unlike HDDs, flash blocks cannot be overwritten and each P/E cycle wears down the lifespan of blocks gradually. Repeatedly program/erase cycles performed on the same memory cells will eventually cause some blocks to age faster than others. This would bring flash storages to their end of service term sooner. Global wear leveling is an important mechanism that levels out the wearing of all blocks so that the wearing-down of all blocks can be almost evenly distributed. This will increase the lifespan of SSDs.

5.4 DataDefender™

Apacer's DataDefender is an advanced technology of power failure management which combines both firmware and hardware mechanisms to ensure data integrity. When power disruption occurs, the low voltage detector will be triggered. When this happens, the SSD's protection mechanism is activated and cuts off data transmission from the host. Once the power supply is resumed, the firmware protection mechanism will ensure the integrity of the firmware as well as the data already written into the NAND flash media.

5.5 ATA Secure Erase

ATA Secure Erase is an ATA disk purging command currently embedded in most of the storage drives. Defined in ATA specifications, (ATA) Secure Erase is part of Security Feature Set that allows storage drives to erase all user data areas. The erase process usually runs on the firmware level as most of the ATA-based storage media currently in the market are built-in with this command. ATA Secure Erase can securely wipe out the user data in the drive and protects it from malicious attack.

5.6 Flash Translation Layer – Page Mapping

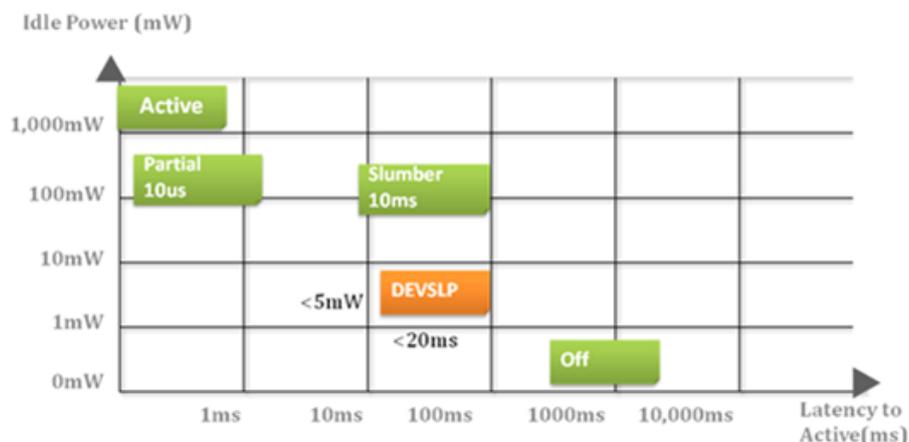
Page mapping is an advanced flash management technology whose essence lies in the ability to gather data, distribute the data into flash pages automatically, and then schedule the data to be evenly written. Page-level mapping uses one page as the unit of mapping. The most important characteristic is that each logical page can be mapped to any physical page on the flash memory device. This mapping algorithm allows different sizes of data to be written to a block as if the data is written to a data pool and it does not need to take extra operations to process a write command. Thus, page mapping is adopted to increase random access speed and improve SSD lifespan, reduce block erase frequency, and achieve optimized performance and lifespan.

5.7 TRIM

TRIM is a SATA command that helps improve the read/write performance and efficiency of solid-state drives (SSD). The command enables the host operating system to inform SSD controller which blocks contain invalid data, mostly because of the erase commands from host. The invalid will be discarded permanently and the SSD will retain more space for itself.

5.8 DEVSLP (DevSleep or DEVSLP) Mode

Device Sleep is a feature that allows SATA devices to enter a low power mode by designating a particular pin as DEVSLP signal with an aim to reducing power consumption.



5.9 SATA Power Management

By complying with SATA 6 Gb/s specifications, the SSD supports the following SATA power saving modes:

- ACTIVE: PHY ready, full power, TX & RX operational
- PARTIAL: Reduces power, resumes in under 10 μ s (microseconds)
- SLUMBER: Reduces power, resumes in under 10 ms (milliseconds)
- HIPM: Host-Initiated Power Management
- DIPM: Device-Initiated Power Management
- AUTO-SLUMBER: Automatic transition from partial to slumber.
- Device Sleep (DevSleep or DEVSLP): PHY powered down; power consumption \leq 5 mW; host assertion time \leq 10 ms; exit timeout from this state \leq 20 ms (unless specified otherwise in SATA Identify Device Log).

Note: The behaviors of power management features would depend on host/device settings.

5.10 SLC-liteX

Apacer's 3D NAND SLC-liteX technology breaks through the limitations of existing technology and provides up to 100,000 P/E cycles, which is over 33 times more than MLC or industrial 3D TLC. Powered by carefully selected NAND components, the firmware structure is specifically optimized to enhance NAND flash stability during daily operations, and the error handling algorithm is significantly improved to avoid any unexpected ECC errors. The longest lifespans are therefore available at reasonable cost.

5.11 SMART Read Refresh™

Apacer's SMART Read Refresh plays a proactive role in avoiding read disturb errors from occurring to ensure health status of all blocks of NAND flash. Developed for read-intensive applications in particular, SMART Read Refresh is employed to make sure that during read operations, when the read operation threshold is reached, the data is refreshed by re-writing it to a different block for subsequent use.

6. Security and Reliability Features

6.1 Advanced Encryption Standard

Advanced Encryption Standard (AES) is a specification for the encryption of electronic data. AES has been adopted by the U.S. government since 2001 to protect classified information and is now widely implemented in embedded computing applications. The AES algorithm used in software and hardware is symmetric so that encrypting/decrypting requires the same encryption key. Without the key, the encrypted data is inaccessible to ensure information security.

Notably in flash memory applications, AES 256-bit hardware encryption is the mainstream to protect sensitive or confidential data. The hardware encryption provides better performance, reliability, and security than software encryption. It uses a dedicated processor, which is built inside the controller, to process the encryption and decryption. This enormously shortens the processing time and makes it efficient.

6.2 Thermal Sensor

Apacer Thermal Sensor is a digital temperature sensor with serial interface. By using designated pins for transmission, storage device owners are able to read temperature data.

6.3 End-to-End Data Protection

End-to-End Data Protection is a feature implemented in Apacer SSD products that extends error control to cover the entire path from the host computer to the drive and back, and ensure data integrity at multiple points in the path to enable reliable delivery of data transfers. Unlike ECC which does not exhibit the ability to determine the occurrence of errors throughout the process of data transmission, End-to-End Data Protection allows SSD controller to identify an error created anywhere in the path and report the error to the host computer before it is written to the drive. This error-checking and error-reporting mechanism therefore guarantees the trustworthiness and reliability of the SSD.

7. Software Interface

7.1 Command Set

Table 7-1 summarizes the ATA commands supported by SH250-CFast.

Table 7-1 Command Set

| Code | Command | Code | Command |
|------|------------------------------|------|-------------------------|
| E5h | CHECK POWER MODE | F4h | SECURITY ERASE UNIT |
| 06h | DATA SET MANAGEMENT | F5h | SECURITY FREEZE LOCK |
| 92h | DOWNLOAD MICROCODE | F1h | SECURITY SET PASSWORD |
| 90h | EXECUTE DEVICE DIAGNOSTIC | F2h | SECURITY UNLOCK |
| E7h | FLUSH CACHE | 70h | SEEK |
| EAh | FLUSH CACHE EXT | EFh | SET FEATURES |
| ECh | IDENTIFY DEVICE | C6h | SET MULTIPLE MODE |
| E3h | IDLE | E6h | SLEEP |
| E1h | IDLE IMMEDIATE | B0h | SMART |
| 91h | INITIALIZE DEVICE PARAMETERS | E2h | STANDBY |
| E4h | READ BUFFER | E0h | STANDBY IMMEDIATE |
| C8h | READ DMA | E8h | WRITE BUFFER |
| 25h | READ DMA EXT | CAh | WRITE DMA |
| 60h | READ FPDMA QUEUED | 35h | WRITE DMA EXT |
| C4h | READ MULTIPLE | 3Dh | WRITE DMA FUA EXT |
| 29h | READ MULTIPLE EXT | 61h | WRITE FPDMA QUEUED |
| 2Fh | READ LOG EXT | 3Fh | WRITE LOG EXT |
| 47h | READ LOG DMA EXT | 57h | WRITE LOG DMA EXT |
| 20h | READ SECTOR | C5h | WRITE MULTIPLE |
| 24h | READ SECTOR EXT | 39h | WRITE MULTIPLE EXT |
| 40h | READ VERIFY SECTORS | CEh | WRITE MULTIPLE FUA EXT |
| 42h | READ VERIFY SECTORS EXT | 30h | WRITE SECTOR |
| 10h | RECALIBRATE | 34h | WRITE SECTOR EXT |
| F6h | SECURITY DISABLE PASSWORD | 45h | WRITE UNCORRECTABLE EXT |
| F3h | SECURITY ERASE PREPARE | | |

7.2 S.M.A.R.T.

S.M.A.R.T. is an abbreviation for Self-Monitoring, Analysis and Reporting Technology, a self-monitoring system that provides indicators of drive health as well as potential disk problems. It serves as a warning for users from unscheduled downtime by monitoring and displaying critical drive information. Ideally, this should allow taking proactive actions to prevent drive failure and make use of S.M.A.R.T. information for future product development reference.

Apacer devices use the standard SMART command B0h to read data out from the drive to activate our S.M.A.R.T. feature that complies with the ATA/ATAPI specifications. S.M.A.R.T. Attribute IDs shall include initial bad block count, total later bad block count, maximum erase count, average erase count, power on hours and power cycle. When the S.M.A.R.T. Utility running on the host, it analyzes and reports the disk status to the host before the device reaches in critical condition.

Note: Attribute IDs may vary from product models due to various solution design and supporting capabilities.

Apacer memory products come with S.M.A.R.T. commands and subcommands for users to obtain information of drive status and to predict potential drive failures. Users can take advantage of the following commands/subcommands to monitor the health of the drive.

Table 7-2 SMART Subcommand Set

| Code | SMART Subcommand |
|------|-----------------------------------|
| D0h | READ DATA |
| D1h | READ ATTRIBUTE THRESHOLDS |
| D2h | ENABLE/DISABLE ATTRIBUTE AUTOSAVE |
| D4h | EXECUTE OFF-LINE IMMEDIATE |
| D5h | SMART READ LOG |
| D6h | SMART WRITE LOG |
| D8h | ENABLE OPERATIONS |
| D9h | DISABLE OPERATIONS |
| DAh | RETURN STATUS |

Table 7-3 General SMART Attribute Structure

| Byte | Description |
|-------|-------------|
| 0 | ID (Hex) |
| 1 – 2 | Status Flag |
| 3 | Value |
| 4 | Worst |
| 5*-11 | Raw Data |

*Byte 5: LSB

Table 7-4 SMART Attribute ID List

| ID (Hex) | Attribute Name |
|-----------------|------------------------------------|
| 9 (0x09) | Power-on Hours |
| 12 (0x0C) | Power Cycle Count |
| 163 (0xA3) | Max. Erase Count |
| 164 (0xA4) | Avg. Erase Count |
| 166 (0xA6) | Total Later Bad Block Count |
| 167 (0xA7) | SSD Protect Mode (Vendor Specific) |
| 168 (0xA8) | SATA PHY Error Count |
| 171 (0xAB) | Program Fail Count |
| 172 (0xAC) | Erase Fail Count |
| 175 (0xAF) | Bad Cluster Table Count |
| 192 (0xC0) | Unexpected Power Loss Count |
| 194 (0xC2) | Temperature |
| 231 (0xE7) | Lifetime Left |
| 241 (0xF1) | Total Sectors of Write |

8. Electrical Specifications

8.1 Operating Voltage

Table 8-1 lists the supply voltage for SH250-CFast 2.0.

Table 8-1 Operating Range

| Parameter | Symbol | Min | Type | Max | Units |
|--------------|--------|-------|------|-------|-------|
| Power Supply | Vcc | 3.135 | 3.3 | 3.465 | V |

8.2 Power Consumption

Table 8-2 lists the power consumption for SH250-CFast 2.0.

Table 8-2 Power Consumption

| Capacity | 10 GB | 20 GB | 40 GB | 80 GB | 160 GB |
|-------------|-------|-------|-------|-------|--------|
| Mode | | | | | |
| Active (mA) | 245 | 325 | 370 | 420 | 415 |
| Idle (mA) | 70 | 70 | 70 | 75 | 70 |

Notes:

- All values are typical and may vary depending on flash configurations or host system settings.
- Active power is an average power measurement performed using CrystalDiskMark with 128KB sequential read/write transfers.

9. Mechanical Specifications

9.1 Dimensions

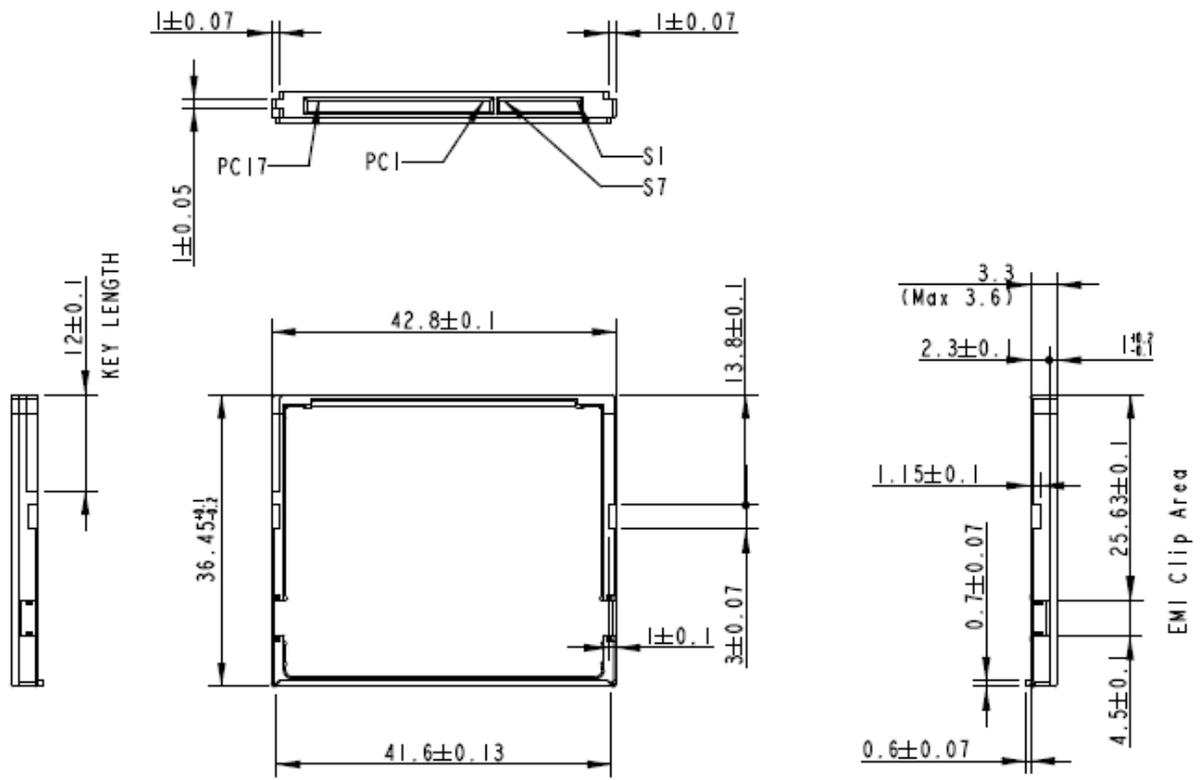


Figure 9-1 Physical Dimensions

Unit: mm

9.2 Write Protect Switch (optional)

Apacer implements the Virtual Write scheme that allows write commands to go through the flash controller and data temporarily stored, but no data has been actually written into the flash. Once the system is reset and rebooted, the temporarily stored data will be lost and nowhere to be found in the system. Since the Virtual Write scheme runs at device level, it requires no software or driver installation and is independent from the host OS.

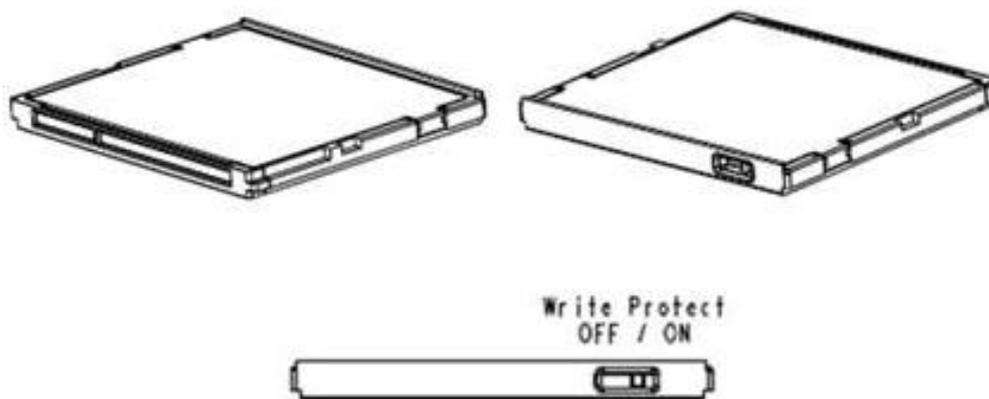


Figure 9-2 Write Protect Switch

9.3 Net Weight

Table 9-1 Net Weight

| Capacity | Net Weight (g ± 5%) |
|----------|---------------------|
| 10GB | 7.72 |
| 20GB | 8.23 |
| 40GB | 9.32 |
| 80GB | 9.33 |
| 160GB | 9.32 |

10. Product Ordering Information

10.1 Product Code Designations

Apacer's SH250-CFast SSD is available in different configurations and densities. See the chart below for a comprehensive list of options for the SH250-CFast series devices.

| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 | 16 |
|------|---|---|---|---|---|---|---|---|---|----|----|----|----|----|----|----|
| | A | A | 2 | . | 2 | 5 | 9 | X | X | X | . | 0 | 0 | 1 | E | 9 |

| | |
|--|--|
| Code 1-3 (Product Line & Form Factor) | MDC+CFS |
| Code 5-6 (Model/Solution) | SH250 |
| Code 7-8 (Product Capacity) | 9F: 10GB 9G: 20GB 9H: 40GB 9J: 80GB 9K: 160GB |
| Code 9 (Flash Type & Product Temp) | Y: 3D SLC-lite standard temperature Z: 3D SLC-lite wide temperature |
| Code 10 (Product Spec) | A: STD without Write Protect Switch B: With Write Protect Switch |
| Code 12-14 (Version Number) | Random numbers generated by system |
| Code 15-16 (Firmware Version) | SLC-liteX Thermal Sensor DEVSLP |

10.2 Valid Combinations

The following tables list the available models of the SH250-CFast series which are in mass production or will be in mass production. Consult your Apacer sales representative to confirm availability of valid combinations and to determine availability of new combinations.

10.2.1 Without Write Protect Switch

| Capacity | Standard Temperature | Wide Temperature |
|----------|----------------------|------------------|
| 10GB | AA2.259FYA.001E9 | AA2.259FZA.001E9 |
| 20GB | AA2.259GYA.001E9 | AA2.259GZA.001E9 |
| 40GB | AA2.259HYA.001E9 | AA2.259HZA.001E9 |
| 80GB | AA2.259JYA.001E9 | AA2.259JZA.001E9 |
| 160GB | AA2.259KYA.001E9 | AA2.259KZA.001E9 |

10.2.2 With Write Protect Switch (optional)

| Capacity | Standard Temperature | Wide Temperature |
|----------|----------------------|------------------|
| 10GB | AA2.259FYB.001E9 | AA2.259FZB.001E9 |
| 20GB | AA2.259GYB.001E9 | AA2.259GZB.001E9 |
| 40GB | AA2.259HYB.001E9 | AA2.259HZB.001E9 |
| 80GB | AA2.259JYB.001E9 | AA2.259JZB.001E9 |
| 160GB | AA2.259KYB.001E9 | AA2.259KZB.001E9 |

Revision History

| Revision | Description | Date |
|----------|--|-----------|
| 1.0 | Initial release | 1/17/2020 |
| 1.1 | <ul style="list-style-type: none"> - Changed SATA 6.0 Gbps to SATA 6 Gb/s in accordance with SATA naming guidelines - Updated operating/non-operating vibration spec at Table 4-3 Environmental Specifications - Capitalized every letter for commands at 7.1 Command Set and SMART subcommand at 7.2 S.M.A.R.T. | 3/18/2020 |
| 1.2 | Added MIL-STD-810G to 4.5 Certification and Compliance | 3/20/2020 |
| 1.3 | <ul style="list-style-type: none"> - Updated MTBF from >1,000,000 hours to >3,000,000 hours - Updated Table 4-1 by changing max LBA to total LBA - Updated the description of 5.2 Bad Block Management | 6/22/2020 |
| 1.4 | Removed Hyper Cache Technology support | 1/10/2022 |
| 1.5 | <ul style="list-style-type: none"> - Removed over-provisioning support - Updated Performance, Endurance and Power Consumption on Specifications Overview page - Updated Tabled 4-2, 4-4, 7-1 and 8-2 - Changed storage temp. from -40°C ~100°C to -55°C ~100°C - Changed P/E cycle from 30K to 100K - Updated the description of 5.10 SLC-liteX - Updated 10. Product Ordering Information by changing product temp. (code 9) and firmware version (code 15-16) | 4/1/2022 |

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